

STGW30NC60KD

30 A - 600 V - short circuit rugged IGBT

Features

- Low on-voltage drop (V_{CE(sat)})
- Low C_{res} / C_{ies} ratio (no cross conduction susceptibility)
- Short circuit withstand time 10 µs
- IGBT co-packaged with ultra fast free-wheeling diode

Applications

- High frequency inverters
- Motor drivers



This IGBT utilizes the advanced PowerMESH™ process resulting in an excellent trade-off between switching performance and low on-state behavior.

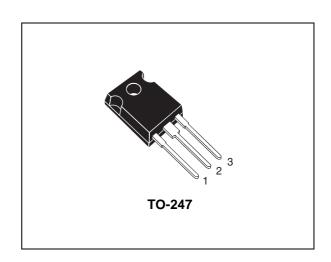


Figure 1. Internal schematic diagram

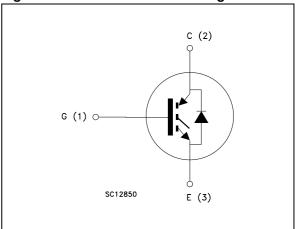


Table 1. Device summary

Order code	Marking Package		Packaging	
STGW30NC60KD	GW30NC60KD	TO-247	Tube	

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STGW30NC60KD Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{CES}	Collector-emitter voltage (V _{GE} = 0)	600	V
I _C ⁽¹⁾	Collector current (continuous) at T _C = 25 °C	60	Α
I _C ⁽¹⁾	Collector current (continuous) at T _C = 100 °C	28	Α
I _{CL} ⁽²⁾	Turn-off latching current	125	Α
I _{CP} ⁽³⁾	Pulsed collector current 125		Α
V _{GE}	Gate-emitter voltage ±20		V
I _F	Diode RMS forward current at T _C = 25 °C 30		Α
I _{FSM}	Surge non repetitive forward current t _p = 10 ms sinusoidal	120	А
P _{TOT}	Total dissipation at $T_C = 25$ °C 200		W
t _{scw}	Short circuit withstand time, $V_{CE} = 0.5 V_{(BR)CES}$ $T_j = 125^{\circ}C$, $R_G = 10 \Omega$, $V_{GE} = 12 V$		μs
Tj	Operating junction temperature	- 55 to 150	°C

1. Calculated according to the iterative formula:

$$I_{c}(T_{c}) = \frac{T_{J(MAX)} - T_{c}}{R_{thj-c} \times V_{CE(sat)(MAX)} \cdot (T_{c}, I_{c})}$$

- 2. $V_{clamp} = 80\%, (V_{CES}), T_j = 150^{\circ}C, R_G = 10 \Omega, V_{GE} = 15 V$
- 3. Pulse width limited by max. junction temperature allowed

Table 3. Thermal resistance

Symbol	Parameter	Value	Unit
B	Thermal resistance junction-case IGBT max.	0.625	°C/W
R _{thj-case}	Thermal resistance junction-case diode max. 1.5		°C/W
R _{thj-amb}	Thermal resistance junction-ambient max 50		°C/W

Electrical characteristics STGW30NC60KD

2 Electrical characteristics

(T_{CASE}=25°C unless otherwise specified)

Table 4. Static

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)CES}	Collector-emitter breakdown voltage (V _{GE} = 0)	I _C = 1 mA	600			٧
V _{CE(sat)}	Collector-emitter saturation voltage	V _{GE} = 15 V, I _C = 20 A V _{GE} = 15 V, I _C = 20 A, T _C = 125 °C		2.1	2.7	V V
I _{CES}	Collector cut-off current (V _{GE} = 0)	V _{CE} = 600 V V _{CE} = 600 V, T _C = 125 °C			150 1	μA mA
V _{GE(th)}	Gate threshold voltage	$V_{CE} = V_{GE}$, $I_{C} = 250 \mu A$	4.5		6.5	V
I _{GES}	Gate-emitter cut-off current (V _{CE} = 0)	V _{GE} = ±20 V			±100	nA
9fs ⁽¹⁾	Forward transconductance	$V_{CE} = 15 \text{ V}, I_{C} = 20 \text{ A}$		15		S

^{1.} Pulsed: Pulse duration = 300 µs, duty cycle 1.5%

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{ies} C _{oes} C _{res}	Input capacitance Output capacitance Reverse transfer capacitance	$V_{CE} = 25 \text{ V, f} = 1 \text{ MHz, V}_{GE} = 0$		2170 230 46		pF pF pF
Q _g Q _{ge} Q _{gc}	Total gate charge Gate-emitter charge Gate-collector charge	$V_{CE} = 480 \text{ V, } I_{C} = 20 \text{ A,}$ $V_{GE} = 15 \text{ V}$ (see Figure 18)		96 18 46		nC nC nC

Table 6. Switching on/off (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max	Unit
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	V_{CC} = 480 V, I_{C} = 20 A R_{G} =10 Ω V _{GE} = 15 V, (see Figure 17)		29 12 1520		ns ns A/µs
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	$V_{CC} = 480 \text{ V}, I_{C} = 20 \text{ A}$ $R_{G} = 10 \Omega, V_{GE} = 15 \text{ V},$ $T_{C} = 125 ^{\circ}\text{C} \text{ (see Figure 17)}$		27 14 1360		ns ns A/µs
$t_r(V_{off})$ $t_d(_{off})$ t_f	Off voltage rise time Turn-off delay time Current fall time	V_{CC} = 480 V, I_{C} = 20 A R_{G} =10 Ω V _{GE} = 15 V, (see Figure 17)		36 120 85		ns ns ns
t _r (V _{off}) t _d (_{off}) t _f	Off voltage rise time Turn-off delay time Current fall time	$V_{cc} = 480 \text{ V, } I_{C} = 20 \text{ A,}$ $R_{G} = 10 \Omega \text{ V}_{GE} = 15 \text{ V}$ $T_{C} = 125 \text{ °C}$ (see Figure 17)		75 160 130		ns ns ns

Table 7. Switching energy (inductive load)

Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
Eon E _{off} ⁽¹⁾ E _{ts}	Turn-on switching losses Turn-off switching losses Total switching losses	V_{CC} = 480 V, I_{C} = 20 A R_{G} = 10 Ω V _{GE} = 15 V, (see Figure 17)		350 435 785		μJ μJ μJ
Eon E _{off} ⁽¹⁾ E _{ts}	Turn-on switching losses Turn-off switching losses Total switching losses	V_{CC} = 480 V, I_{C} = 20 A R_{G} = 10 Ω V_{GE} = 15 V, T_{C} = 125 °C (see Figure 17)		590 845 1435		μJ μJ μJ

^{1.} Turn-off losses include also the tail of the collector current.

Electrical characteristics STGW30NC60KD

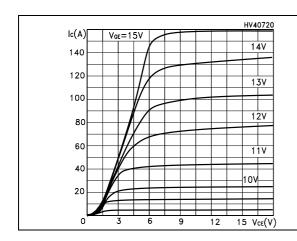
Table 8. Collector-emitter diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _F	Forward on-voltage	I _F = 20 A I _F = 20 A, T _C = 125 °C		2.6 1.6	3.1	V V
t _{rr} Q _{rr} I _{rrm}	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_F = 20 \text{ A}, V_R = 50 \text{ V},$ di/dt = 100 A/ μ s (see Figure 20)		40 50 2.5		ns nC A
t _{rr} Q _{rr} I _{rrm}	Reverse recovery time Reverse recovery charge Reverse recovery current	I_F = 20 A,V _R = 50 V, T_C =125 °C, di/dt = 100 A/ μ s (see Figure 20)		80 180 4.5		ns nC A

2.1 Electrical characteristics (curves)

Figure 2. Output characteristics

Figure 3. Transfer characteristics



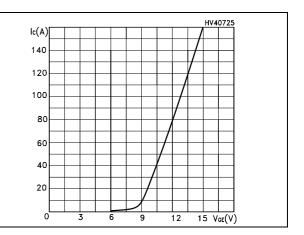
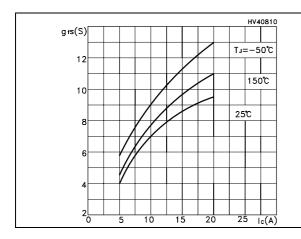


Figure 4. Transconductance

Figure 5. Collector-emitter on voltage vs temperature



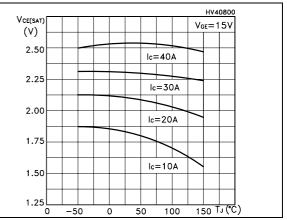
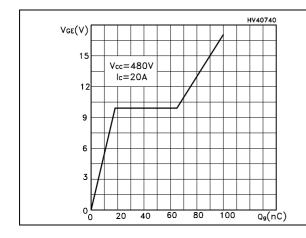
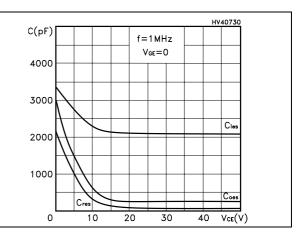


Figure 6. Gate charge vs gate-source voltage Figure 7. Capacitance variations





Electrical characteristics STGW30NC60KD

Figure 8. Normalized gate threshold voltage Figure 9. vs temperature

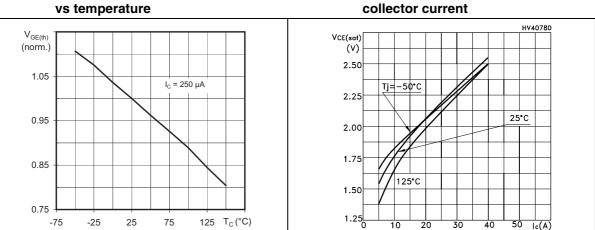


Figure 10. Normalized breakdown voltage vs temperature

Figure 11. Switching losses vs temperature

Collector-emitter on voltage vs

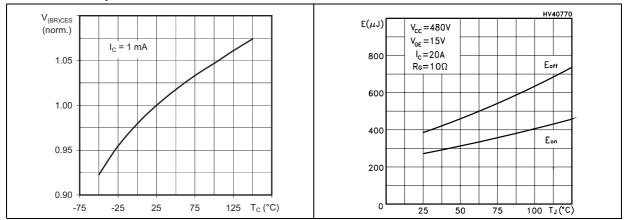
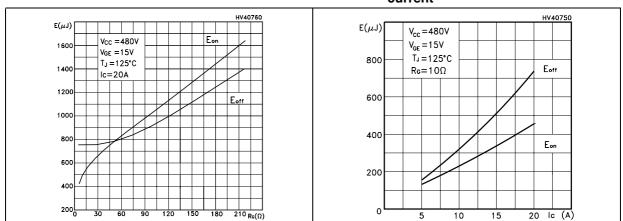


Figure 12. Switching losses vs gate resistance Figure 13. Switching losses vs collector current



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Figure 14. Thermal Impedance

Figure 15. Turn-off SOA

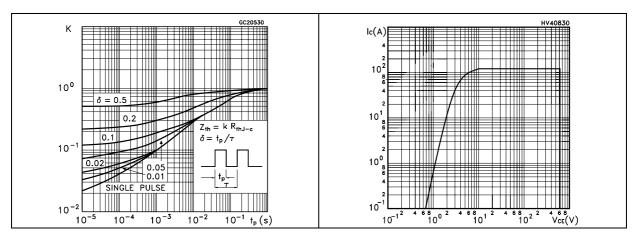
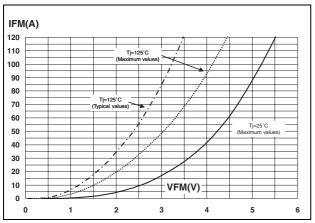


Figure 16. Forward voltage drop versus forward current



Test circuit STGW30NC60KD

3 Test circuit

Figure 17. Test circuit for inductive load switching

Figure 18. Gate charge test circuit

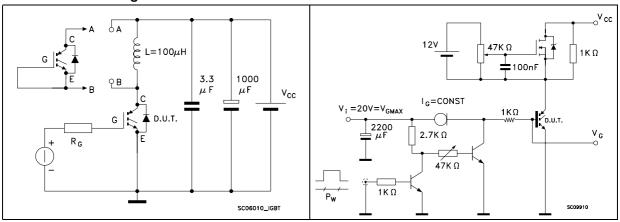
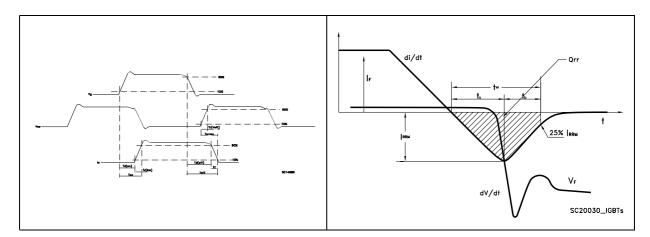


Figure 19. Switching waveforms

Figure 20. Diode recovery times waveform

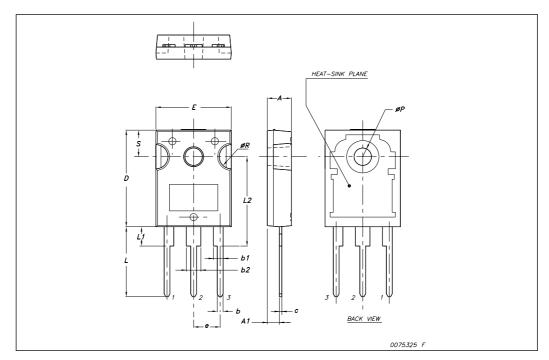


4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

TO-247 Mechanical data

Dim.		mm.	
Dilli.	Min.	Тур	Max.
Α	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
С	0.40		0.80
D	19.85		20.15
Е	15.45		15.75
е		5.45	
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
øΡ	3.55		3.65
øR	4.50		5.50
S		5.50	



STGW30NC60KD Revision history

5 Revision history

Table 9. Document revision history

Date	Revision	Changes
24-Oct-2007	1	Initial release
07-Mar-2008	2	Updated Figure 15: Turn-off SOA

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